ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

NCV7685 RGB Lighting Evaluation Board User's Manuals

ON

ON Semiconductor®

www.onsemi.com

EVAL BOARD USER'S MANUAL



Description

SECO-NCV7685RGB-GEVB is an evaluation board for RGB LEDs lighting application with BLE in automotive which driven by NCV7685 and controlled by RSL10. It is also an interior or exterior lighting reference design for tail or ambient lights to realize general sequential or high end pixelated LEDs controlling in-vehicle network. The user can set RGB LED's color and intensity by mobile APP to show customized information or animation.

In general, the user are prefer to use fixed address in multiple NCV7685 application. It leads to add one more procedure to pre-programming each chips' address in mass production stage. In addition, it is inconvenient for maintenance in the aftermarket. In firmware of this evaluation board, it use floating address setting method, each time when power on the board, the NCV7685 will be assigned an address which defined by customer, but not locked into OTP registers. The user can realize this function by using either RSL10's GPIO or IO expender (PAC9655).

In firmware, the driver APIs divided into four levels: Peripheral, Chip, Board and customer application. User can directly include the chips and board APIs in their own project, and modify the application APIs according to their applications. This will fasten develop period to market.

The board conceived for use as a plug and play environment to testing.

Nominal supply voltage is 12 V (Supply voltage range 12–24 V). In switch mode, four fixed animations shown; the RGB LEDs' color and intensity setting by user mobile APP in BLE mode.

Features

- Plug and Play; Switch and BLE Mode to Show Animations
- 16 RGB LEDs (48 Channels), each Current Programmable Sources up to 60 mA
- Independent PWM Duty Cycle Control for each Channel
- On-Chip 150, 300, 600 and 1200 Hz PWM
- Logarithmic or linear independent PWM dimming
- Diagnostic and Protection against Open Load and Under-Voltage, Over Temperature...
- Dynamic Addressing Method for No-Worries in mass production
- Bluetooth® 5 Certified with LE 2M PHY Support
- Rx Sensitivity (Bluetooth Low Energy Mode, 1 Mbps): -94 dBm
- Transmitting Power: -17 to +6 dBm
- Arm Cortex-M3 Processor and LPDSP32
- AEC-Q100 Qualified and PPAP Capable

Architecture and Key Parts

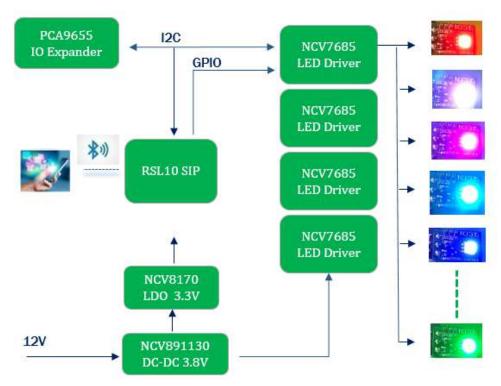


Figure 1. Board Architecture

KEY PARTS

| Chip Part | Description | |
|-----------|---|--|
| NCV7685 | 12 Channels 60 mA LED Linear Current Driver I2C Controllable for Automotive | |
| RSL10 SIP | System-in-Package, Bluetooth 5 Certified | |
| PCA9655 | Remote 16-bit I/O Expander for I2C Bus with Interrupt | |
| NCV8170 | Ultra - Low IQ 150 mA CMOS LDO Regulator | |
| NCV891330 | 3 A, 2 MHz Low-IQ Dual-Mode Step-Down Regulator for Automotive | |

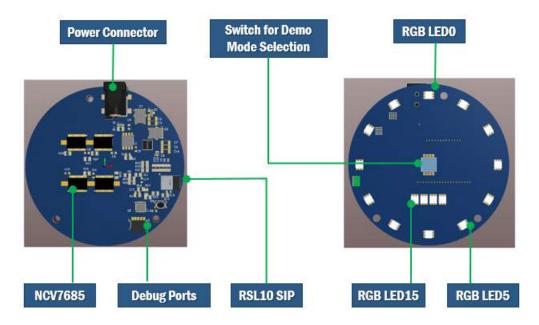


Figure 2. Top and Bottom Layer and Key Components

Operations of NCV7685 RGB LEDs Board

After power on, the board shows the "Welcome" animation, then according to the setting of the switch, the board show four kinds of fixed animations or come into BLE

mode. The functions and operations descripted as below figures:

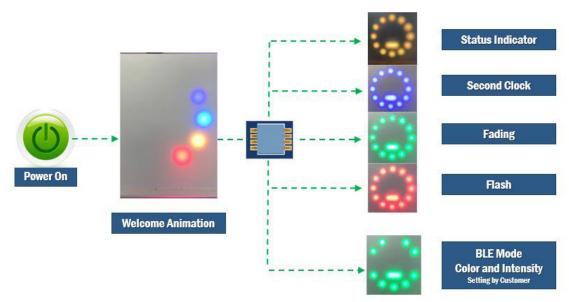


Figure 3. Sequence after Power On

Switch Setting:

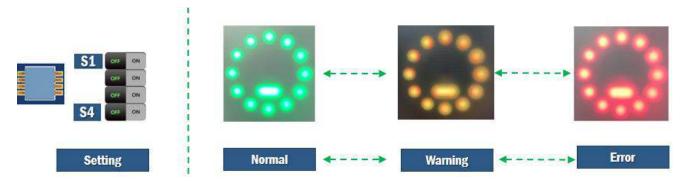


Figure 4. Status Indicator Mode

Status Indicator Mode:

Keep all Switches off; the board comes into status indicator mode. Green means works well, orange means warning and red means error. The color of LEDs changes in gradient from green to orange, then to red; and goes back from red to green. This used as the status indicator for dashboard.

Switch Setting:



Figure 5. Second Clock Mode

Second Clock

Keep Switch S1 on and S2, S3, S4 off, every second, only one LED in blue lights up clockwise direction in turn.

Switch Setting:



Figure 6. Flash Mode

Flash Mode

Keep Switch S2 on and S1, S3, S4 off, all LEDs flash in red.

Switch Setting:



Figure 7. Fading Mode

Fading Mode

Keep Switch S1, S2 on and S3, S4 off, all LEDs fading in green.

Switch Setting:

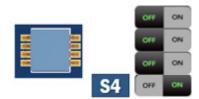


Figure 8. BLE Mode

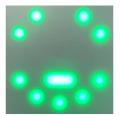


Figure 9. Standby interface in BLE Mode

BLE Mode

Just Keep Switch S4 on and never mind of the setting of S2, S3, S4, the board comes into BLE mode. User use general mobile App to control LED's color and intensity for individual or all LEDs. For example, using "Light Blue" in IOS; "BLE Scanner" or "nRF Connect" in Android OS. It shows a green "smell face" firstly, and then changes the color and intensity according to the received five bytes data by BLE. The first three bytes stands for R, G, B values to mix the color, and the fourth data stands for intensity (4 level brightness For V1). The fifth byte stands for LED number, if this value is greater than 0x0f, all LEDs response. Here are several examples:

Examples: (R, G, B, I, LED No)

(Four level of Intensity, Depends on Firmware)

800080FF00: LED0 in Purple FF00003F01: LED1 in Red

XXXXXX0010: All LEDs turn off as the he intensity is 0

(Never mind RGB's values)

00BFFFFF10: All LEDs in deep sky blue

Here is an example using "Light Blue" App to control RGB lighting board:

- 1. Find and choose Peripheral of "NCV7685 RGB Kit"
- 2. Tap "Send RGB Setting" character
- 3. Set RGB and Intensity values
- 4. The board change color, intensity and LED_No

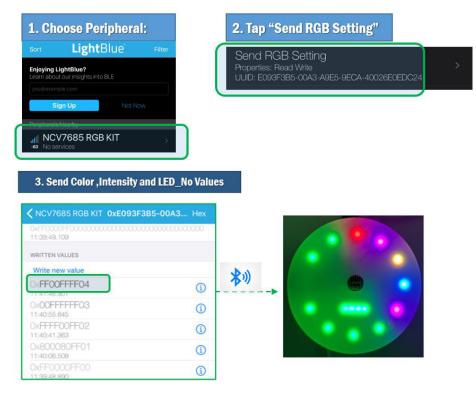


Figure 10. Using 'Light Blue' App to Control the Board

Firmware Setting

Generally, user had better use floating address method in firmware; the configurations can changed in the "ncv7685.h" file. Here are options:

```
1. Floating Address method using SOC GPIO:
```

```
/* Chips number */
/* PCA9655 I2C address */
/* SOC or PCA9655 */
 #define NCV7675 CHIPS NUM 0x04
 #define PCA9655 Address
                                0x22
 #define BY SOC
                                0
                                  1
BY_SOC
 #define BY PCA9655
 #define ADDRESS SETTING
 #define Fix Address
                                   0
 #define Address Had Set
                                   0
2. Floating Address method using PCA9655:
                                               /* Chips number */
 #define NCV7675_CHIPS_NUM 0x04
 #define NCV/0/5_cml-_
#define PCA9655_Address
                                               /* PCA9655 I2C address */
                               0x22
                                0
 #define BY SOC
                                                /* SOC or PCA9655 */
                              1
BY_PCA9655
 #define BY PCA9655
 #define ADDRESS SETTING
 #define Fix Address
 #define Address Had Set
                                   0
3. Fix Address method using PCA9655 or SOC GPIO:
                                               /* Chips number */
 #define NCV7675_CHIPS_NUM 0x04
                                               /* PCA9655 I2C address */
 #define PCA9655 Address
                                0x22
 #define BY SOC
                                0
                                  1
 #define BY PCA9655
```

4. For the board which address had programmed, just set "Address_Had_Set" to 1, So it will skip address setting function:

BY_PCA9655 /* SOC or PCA9655 */

1

Files Structure of Project

```
source
app_basc.c
app_bass.c
app_config.c
app_customss.c
app_msg_handler.c
app_trace.c
ncv7685.c
```

#define ADDRESS_SETTING
#define Fix Address

#define Address Had Set

Figure 11. Files Structure of Project

```
app_basc.c: Battery level indication handler
app_bass.c: Battery Service code
app_config.c: Application configuration source file
app_customss.c: Bluetooth custom service
app_msg_handler.c: Customer defined functions and data
app_trace.c: Trace functions
ncv7685.c: APIs of NCV7685 Chip and Board
app.c: main function
```

Flow Chart of App.c

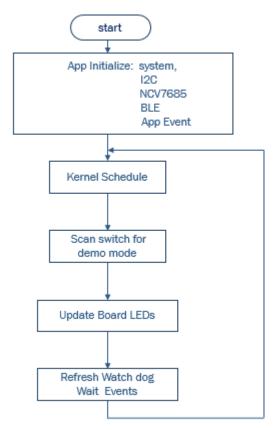


Figure 12. Flow chart of App.c

Schematic

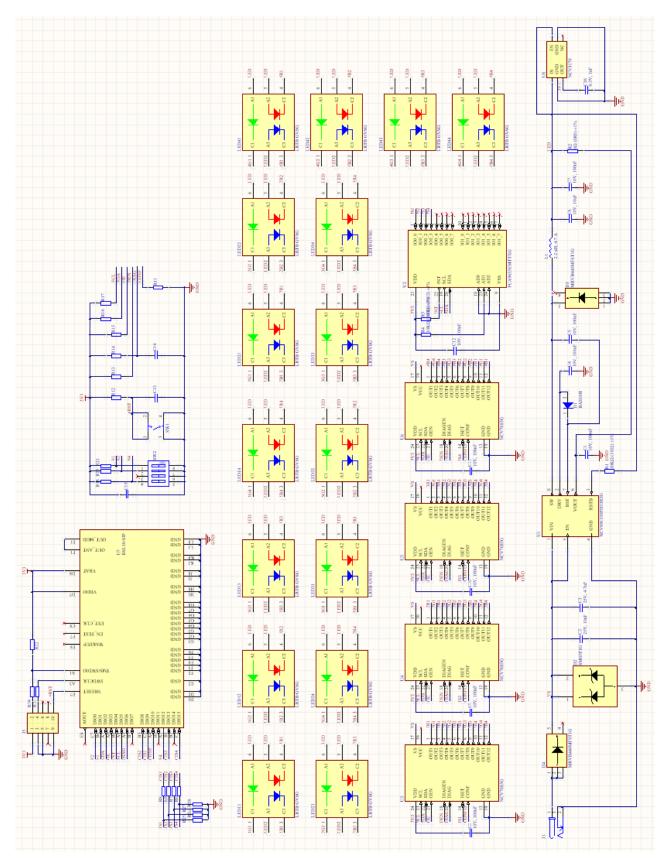


Figure 13. Schematic of Board

Assembly

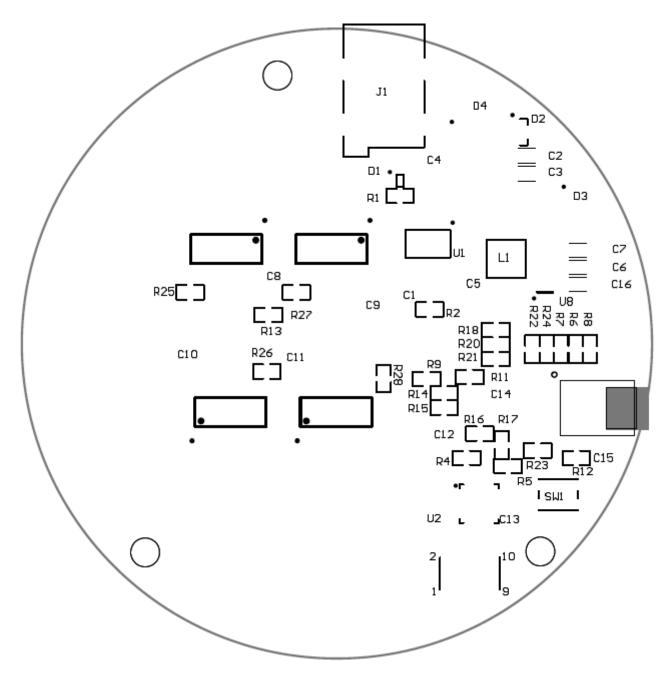


Figure 14. Bottom Side Assembly

Table 1. BILL OF MATERIALS

| Item | Designator | Manufacturer | Comment | Description | Quantity |
|------|---|------------------|-----------------------------|---|----------|
| 1 | C1, C4, C5, C8, C9, C10, C11, C12, C13, C14, C15 | - | 10 V, 100 nF | WCAP-CSGP Ceramic Capacitors, 0603 | 11 |
| 2 | C2 | - | 25 V, 10 μF | WCAP-CSGP Ceramic Capacitors, 1206 | 1 |
| 3 | СЗ | - | 25 V, 4.7 μF | WCAP-CSGP Ceramic Capacitors, 1206 | 1 |
| 4 | C6 | - | 10 V, 10 μF | WCAP-CSGP Ceramic Capacitors, 1206 | 1 |
| 5 | C7 | - | 10 V, 100 nF | WCAP-CSGP Ceramic Capacitors, 1206 | 1 |
| 6 | D1 | ON Semiconductor | BAS16H | Schottky Barrier Diode, | 1 |
| 7 | D3, D4 | ON Semiconductor | NTS560 | Trench Schottky Rectifier, Low Forward Voltage, 60 V, 5 A | 2 |
| 8 | J1 | - | 694106106102 | DC Power Jack Connector, 5 A, 24 V | 1 |
| 9 | J5 | - | 1.27 mm_SMD_Vertical_10 pin | Pin Header WR-PHD, pitch 1.27 mm, | 1 |
| 10 | L1 | - | 2.2 μH, 4.7 A | SMT Shielded Power Inductor | 1 |
| 11 | LED11, LED12, LED13, LED14, LED21, LED22, LED23, LED31, LED31, LED32, LED33, LED34, LED41, LED41, LED42, LED43, LED44 | _ | LRTB GVSG | _ | 16 |
| 12 | R1, R4, R5, R12, R13, R14, R18, R20, R21 | - | 10 kΩ (1002) ±1% | Chip Resistor | 9 |
| 13 | R2, R3 | - | 0 Ω (0R0) ±1% | 'Chip Resistor | 2 |
| 14 | R6, R7, R8, R9, R23, R24 | - | 68 Ω (68R0) ±1% | 'Chip Resistor | 6 |
| 15 | R10 | - | 2.7 kΩ (2701) ±1% | 'Chip Resistor | 1 |
| 16 | R11 | - | 10 Ω (10R0) ±1% | 'Chip Resistor | 1 |
| 17 | R15, R22 | - | 100 kΩ (1003) ±1% | 'Chip Resistor | 2 |
| 18 | R16, R17 | - | 1.5 kΩ (1501) ±1% | 'Chip Resistor | 2 |
| 19 | R25, R26, R27, R28 | - | 2 kΩ (2001) ±1% | 'Chip Resistor | 4 |
| 20 | SW1 | - | 434133025816 | 4.2x3.2 mm J-Bend SMD Tact Switch | 1 |
| 21 | SW2 | - | 416131160804 | SMD Dip Switch | 1 |

Table 1. BILL OF MATERIALS

| Item | Designator | Manufacturer | Comment | Description | Quantity |
|------|-------------------|------------------|------------------|-------------|----------|
| 22 | U1 | ON Semiconductor | NCV891330PD33R2G | - | 1 |
| 23 | U2 | ON Semiconductor | PCA9655EMTTXG | - | 1 |
| 24 | U3, U4, U5, U6 | ON Semiconductor | NCV7685G | - | 4 |
| 25 | U7 | ON Semiconductor | RSL10-SIP | - | 1 |

Bluetooth is a registered trademark of Bluetooth SIG.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

The evaluation board/kit (research and development board/kit) (hereinafter the "board") is not a finished product and is as such not available for sale to consumers. The board is only intended for research, development, demonstration and evaluation purposes and should as such only be used in laboratory/development areas by persons with an engineering/technical training and familiar with the risks associated with handling electrical/mechanical components, systems and subsystems. This person assumes full responsibility/liability for proper and safe handling. Any other use, resale or redistribution for any other purpose is strictly prohibited.

The board is delivered "AS IS" and without warranty of any kind including, but not limited to, that the board is production-worthy, that the functions contained in the board will meet your requirements, or that the operation of the board will be uninterrupted or error free. ON Semiconductor expressly disclaims all warranties, express, implied or otherwise, including without limitation, warranties of fitness for a particular purpose and non-infringement of intellectual property rights.

ON Semiconductor reserves the right to make changes without further notice to any board.

You are responsible for determining whether the board will be suitable for your intended use or application or will achieve your intended results. Prior to using or distributing any systems that have been evaluated, designed or tested using the board, you agree to test and validate your design to confirm the functionality for your application. Any technical, applications or design information or advice, quality characterization, reliability data or other services provided by ON Semiconductor shall not constitute any representation or warranty by ON Semiconductor, and no additional obligations or liabilities shall arise from ON Semiconductor having provided such information or services.

The boards are not designed, intended, or authorized for use in life support systems, or any FDA Class 3 medical devices or medical devices with a similar or equivalent classification in a foreign jurisdiction, or any devices intended for implantation in the human body. Should you purchase or use the board for any such unintended or unauthorized application, you shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the board.

This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and may not meet the technical requirements of these or other related directives.

FCC WARNING - This evaluation board/kit is intended for use for engineering development, demonstration, or evaluation purposes only and is not considered by ON Semiconductor to be a finished end product fit for general consumer use. It may generate, use, or radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment may cause interference with radio communications, in which case the user shall be responsible, at its expense, to take whatever measures may be required to correct this interference.

ON Semiconductor does not convey any license under its patent rights nor the rights of others.

LIMITATIONS OF LIABILITY: ON Semiconductor shall not be liable for any special, consequential, incidental, indirect or punitive damages, including, but not limited to the costs of requalification, delay, loss of profits or goodwill, arising out of or in connection with the board, even if ON Semiconductor is advised of the possibility of such damages. In no event shall ON Semiconductor's aggregate liability from any obligation arising out of or in connection with the board, under any theory of liability, exceed the purchase price paid for the board, if any. For more information and documentation, please visit www.onsemi.com

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative